



A Product Line of Diodes Incorporated



60V N-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

Features

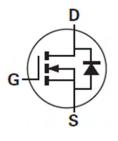
- BV_{DSS} > 60V
- R_{DS(on)} ≤ 5Ω @ V_{GS}= 10V
- Maximum continuous drain current I_D = 270mA
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

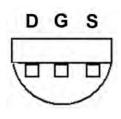
- Case: E-Line (TO-92 Compatible)
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.159 grams (approximate)



Top View



Device Symbol



Bottom View Pin-Out

Ordering Information (Note 4)

Product	Marking	Package	Quantity per box on tape
VN10LPSTZ	VN10LP	E-Line	2,000 per ammo box
VN10LP	VN10LP	E-Line	4,000 loose

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



VN10LP = Product type Marking Code





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	I _D	270	mA
Pulsed Drain Current (Note 6)	I _{DM}	3	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	PD	625	mW
Thermal Resistance, Junction to Ambient	(Note 5)	R _{0JA}	200	°C/W
Thermal Resistance, Junction to Leads	(Note 7)	R _{θJL}	71	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 For a device mounted on 25mm X 25mm X 1.6mm FR-4 PCB with high coverage of single sided 1oz copper, in still air condition.
 Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%. Notes:

7. Thermal resistance from junction to Drain leads 2mm outside plastic compound.





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS				-		
Drain-Source Breakdown Voltage	BV _{DSS}	60		_	V	$I_D = 250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS						_
On state Drain Current (Note 8)	I _{D(on)}	750	_	_	mA	V _{DS} =15 V, V _{GS} =10V
Gate Threshold Voltage	V _{GS(th)}	0.8		2.5	V	$I_D = 1mA$, $V_{DS} = V_{GS}$
Static Drain-Source On-Resistance (Note 8)	P			5.0	Ω	$V_{GS} = 10V, I_D = 500mA$
Static Drain-Source On-Resistance (Note 8)	R _{DS (ON)}			7.5	12	$V_{GS} = 5V, I_D = 200mA$
Forward Transconductance (Notes 8 and 10)	g fs	100		-	mS	$V_{DS} = 15V, I_D = 500mA$
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss			60		
Output Capacitance	C _{oss}	_	_	25	pF	$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_		5		
Turn-On Time (Note 9)	t _(on)	_		10	20	151/ 1 600mA
Turn-Off Time (Note 9)	t _(off)	_		10	ns	$V_{DD} = 15V, I_D = 600mA$

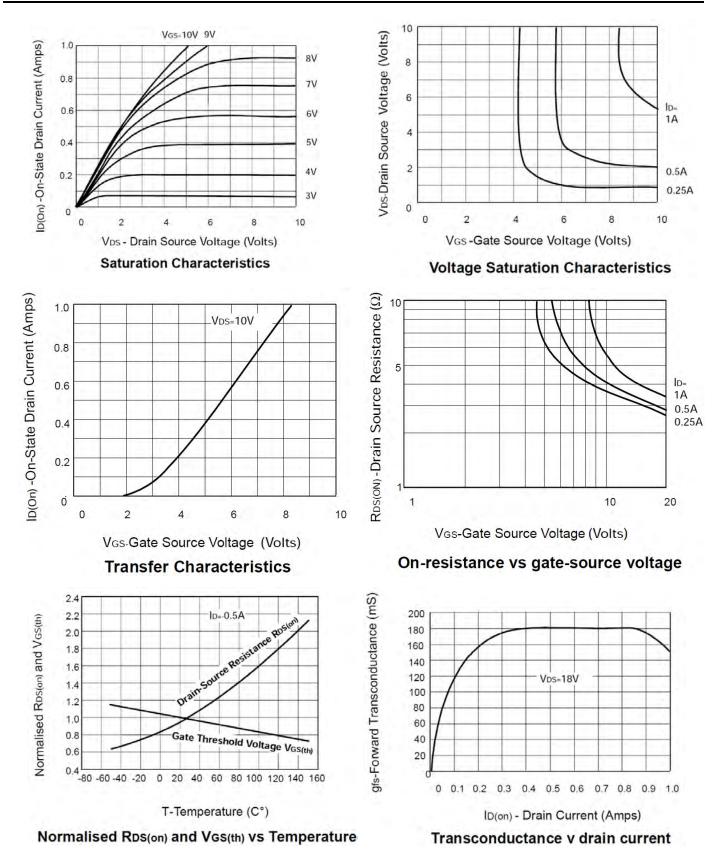
Notes:

Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.
 For design aid only, not subject to production testing.





Typical Characteristics

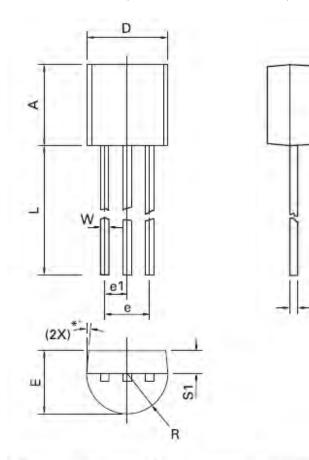






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Dim.	Millin	neters	Inches		
	Min.	Max.	Min.	Max.	
A	4.32	4.95	0.170	0.195	
b	0.36	0.51	0.014	0.020	
E	3.30	3.94	0.130	0.155	
	2.41	2.67	0.095	0.105	
e1	1.14	1.40	0.045	0.055	
L	12.70	15.49	0.500	0.610	
R	2.16	2.41	0.085	0.095	
S1	1.14	1,52	0.045	0.060	
W	0.41	0.56	0.016	0.022	
D	4.45	4.95	0.175	0.195	
*0	4°	6°	4°	6°	

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Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in Inches





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